

100 MHz to 4000 MHz RF/IF Digitally Controlled VGA

ADL5243

Data Sheet

FEATURES

Operating frequency from 100 MHz to 4000 MHz Digitally controlled VGA with serial and parallel interfaces 6-bit, 0.5 dB digital step attenuator 31.5 dB gain control range with ±0.25 dB step accuracy **Gain Block Amplifier 1** Gain: 19.2 dB at 2140 MHz OIP3: 40.2 dBm at 2140 MHz P1dB: 19.8 dBm at 2140 MHz Noise figure: 2.9 dB at 2140 MHz 1/4 W Driver Amplifier 2 Gain: 14.2 dB at 2140 MHz OIP3: 41.1 dBm at 2140 MHz P1dB: 26.0 dBm at 2140 MHz Noise figure: 3.7 dB at 2140 MHz Gain block, DSA, or ¼ W driver amplifier can be first Low quiescent current of 175 mA The companion ADL5240 integrates a gain block with DSA

APPLICATIONS

Wireless infrastructure Automated test equipment RF/IF gain control

GENERAL DESCRIPTION

The ADL5243 is a high performance, digitally controlled variable gain amplifier operating from 100 MHz to 4000 MHz.

The VGA integrates two high performance amplifiers and a digital step attenuator (DSA). Amplifier 1 (AMP1) is an internally matched gain block amplifier with 20 dB gain, and Amplifier 2 (AMP2) is a broadband $\frac{1}{4}$ W driver amplifier that requires very few external tuning components. The DSA is 6-bit with a 31.5 dB gain control range, 0.5 dB steps, and ± 0.25 dB step accuracy. The attenuation of the DSA can be controlled using a serial or parallel interface.

The gain block and DSA are internally matched to 50Ω at their inputs and outputs, and all three internal devices are separately biased. The separate bias allows all or part of the ADL5243 to be used, which allows for easy reuse throughout a design. The pinout of the ADL5243 also enables the gain block, DSA, or ¹/₄ W driver amplifier to be first, giving the VGA maximum flexibility in a signal chain.

The ADL5243 consumes 175 mA and operates off a single supply ranging from 4.75 V to 5.25 V. The VGA is packaged in a thermally efficient, 5 mm \times 5 mm, 32-lead LFCSP and is fully specified for operation from -40 °C to +85 °C. A fully populated evaluation board is available.

FUNCTIONAL BLOCK DIAGRAM



Figure 1.

Rev. B

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 One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A.

 Tel: 781.329.4700
 www.analog.com

 Fax: 781.461.3113
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REVISION HISTORY

8/12—Rev. A to Rev. B

Changes to General Description Section1
Changes to Table 1
Changes to Table 311
Changes to Figure 312
Changes to Figure 3317
Added Figure 47 and Figure 49, Renumbered Sequentially19
Change to Figure 58
Changes to ADL5243 Amplifier 2 Matching Section, Table 8,
and Table 925
Added Figure 61 and Figure 6226
Changes to Figure 63 and Figure 6427
Added Figure 65; Changes to Figure 6628
Added Figure 67; Changes to Figure 6829
Added Figure 69

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Changes to ADL5243 Loop Performance Section; Added	
Figure 71, Figure 72, and Table 10, Renumbered Sequentially	.31
Added Proper Driving Level for the Optimum ACLR Section	
and Figure 73	.32
Changes to Evaluation Board Section and Table 11	.33
Changes to Figure 75	.34
Added Figure 76	.35
Changes to Figure 77 and Figure 78	.36
Added Figure 79	.37
8/11—Rev. 0 to Rev. A	
Changes to Features Section	1
7/11—Revision 0: Initial Version	

SPECIFICATIONS

VDD = 5 V, VCC = 5 V, VCC2 = 5 V, $T_A = 25^{\circ}C$.

Table 1.

Parameter	Conditions	Min	Тур	Мах	Unit
OVERALL FUNCTION					
Frequency Range		100		4000	MHz
AMPLIFIER 1 FREQUENCY = 150 MHz	Using the AMP1IN and AMP1OUT pins				
Gain			18.2		dB
vs. Frequency	±50 MHz		±0.97		dB
vs. Temperature	$-40^{\circ}C \le T_A \le +85^{\circ}C$		±0.07		dB
vs. Supply	4.75 V to 5.25 V		±0.03		dB
Input Return Loss	S11		-10.4		dB
Output Return Loss	S22		-8.2		dB
Output 1 dB Compression Point			18.4		dBm
Output Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 3 \text{ dBm/tone}$		29.5		dBm
Noise Figure			2.8		dB
AMPLIFIER 1 FREQUENCY = 450 MHz	Using the AMP1IN and AMP1OUT pins				
Gain			20.6		dB
vs. Frequency	±50 MHz		±0.10		dB
vs. Temperature	$-40^{\circ}C \le T_{A} \le +85^{\circ}C$		±0.36		dB
vs. Supply	4.75 V to 5.25 V		±0.01		dB
Input Return Loss	S11		-17.8		dB
Output Return Loss	S22		-16.5		dB
Output 1 dB Compression Point			19.5		dBm
Output Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 3 \text{ dBm/tone}$		38.4		dBm
Noise Figure			2.8		dB
AMPLIFIER 1 FREQUENCY = 748 MHz	Using the AMP1IN and AMP1OUT pins				
Gain			20.8		dB
vs. Frequency	±50 MHz		±0.02		dB
vs. Temperature	$-40^{\circ}C \le T_{A} \le +85^{\circ}C$		±0.32		dB
vs. Supply	4.75 V to 5.25 V		±0.01		dB
Input Return Loss	S11		-22.0		dB
Output Return Loss	S22		-21.6		dB
Output 1 dB Compression Point			19.6		dBm
Output Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 3 \text{ dBm/tone}$		39.6		dBm
Noise Figure			2.7		dB
AMPLIFIER 1 FREQUENCY = 943 MHz	Using the AMP1IN and AMP1OUT pins				
Gain		19.0	20.3	22.0	dB
vs. Frequency	±18 MHz		±0.01		dB
vs. Temperature	$-40^{\circ}C \le T_{A} \le +85^{\circ}C$		±0.28		dB
vs. Supply	4.75 V to 5.25 V		±0.02		dB
Input Return Loss	S11		-24.0		dB
Output Return Loss	S22		-21.5		dB
Output 1 dB Compression Point		18.5	19.9		dBm
Output Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 3 \text{ dBm/tone}$	10.5	40.4		dBm
Noise Figure			2.7		dB

Parameter	Conditions	Min	Тур	Мах	Uni
AMPLIFIER 1 FREQUENCY = 1960 MHz	Using the AMP1IN and AMP1OUT pins				
Gain			19.5		dB
vs. Frequency	±30 MHz		±0.02		dB
vs. Temperature	$-40^{\circ}C \le T_A \le +85^{\circ}C$		±0.26		dB
vs. Supply	4.75 V to 5.25 V		±0.04		dB
Input Return Loss	S11		-13.5		dB
Output Return Loss	S22		-12.4		dB
Output 1 dB Compression Point			19.6		dBr
Output Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 3 \text{ dBm/tone}$		40.4		dBr
Noise Figure			2.9		dB
AMPLIFIER 1 FREQUENCY = 2140 MHz	Using the AMP1IN and AMP1OUT pins		2.0		0.0
Gain		17.5	19.2	21.5	dB
vs. Frequency	±30 MHz	17.5	±0.02	21.5	dB
vs. Temperature	$-40^{\circ}C \le T_{A} \le +85^{\circ}C$		±0.02 ±0.26		dB
vs. Supply	4.75 V to 5.25 V		±0.20		dB
Input Return Loss	4.75 V to 5.25 V S11		±0.05 -13.3		dB
Output Return Loss	S11 S22		-13.3 -12.2		dB
•	322	17.5	-12.2 19.8		dBr
Output 1 dB Compression Point Output Third-Order Intercept	Af 1 Mile D 2 dBre /to no	17.5			
	$\Delta f = 1 \text{ MHz}, P_{OUT} = 3 \text{ dBm/tone}$		40.2		dBr
Noise Figure			2.9		dB
AMPLIFIER 1 FREQUENCY = 2630 MHz	Using the AMP1IN and AMP1OUT pins	47.5			10
Gain		17.5	19.0	21.5	dB
vs. Frequency	±60 MHz		±0.03		dB
vs. Temperature	$-40^{\circ}C \le T_A \le +85^{\circ}C$		±0.22		dB
vs. Supply	4.75 V to 5.25 V		±0.05		dB
Input Return Loss	S11		-17.3		dB
Output Return Loss	S22		-12.3		dB
Output 1 dB Compression Point		17.5	19.5		dBr
Output Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 3 \text{ dBm/tone}$		39.5		dBr
Noise Figure			2.9		dB
AMPLIFIER 1 FREQUENCY = 3600 MHz	Using the AMP1IN and AMP1OUT pins				
Gain			18.0		dB
vs. Frequency	±100 MHz		±0.10		dB
vs. Temperature	$-40^{\circ}C \le T_A \le +85^{\circ}C$		±0.05		dB
vs. Supply	4.75 V to 5.25 V		±0.12		dB
Input Return Loss	S11		-30.7		dB
Output Return Loss	S22		-9.0		dB
Output 1 dB Compression Point			18.0		dBr
Output Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 3 \text{ dBm/tone}$		34.6		dBr
Noise Figure			3.3		dB
AMPLIFIER 2 FREQUENCY = 150 MHz	Using the AMP2IN and AMP2OUT pins				
Gain			20.8		dB
vs. Frequency	±50 MHz		±1.1		dB
vs. Temperature	$-40^{\circ}C \le T_{A} \le +85^{\circ}C$		±0.3		dB
vs. Supply	4.75 V to 5.25 V		±0.03		dB
Input Return Loss	S11		<u>+</u> 0.05 −11.0		dB
Output Return Loss	S22		-6.5		dB
Output 1 dB Compression Point			22.8		dBr
Output Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 5 \text{ dBm/tone}$		40.6		dBr
Noise Figure	$\Delta I = I W I Z, I U = J U D I / U I P$		40.8 6.3		dB

Parameter	Conditions	Min Typ Max	Unit
AMPLIFIER 2 FREQUENCY = 450 MHz	Using the AMP2IN and AMP2OUT pins		
Gain		16.4	dB
vs. Frequency	±50 MHz	±0.5	dB
vs. Temperature	$-40^{\circ}C \le T_A \le +85^{\circ}C$	±0.35	dB
vs. Supply	4.75 V to 5.25 V	±0.07	dB
Input Return Loss	S11	-9.0	dB
Output Return Loss	S22	-8.0	dB
Output 1 dB Compression Point		23.2	dBm
Output Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 5 \text{ dBm/tone}$	38.1	dBm
Noise Figure		6.2	dB
AMPLIFIER 2 FREQUENCY = 748 MHz	Using the AMP2IN and AMP2OUT pins		
Gain		17.5	dB
vs. Frequency	±50 MHz	±0.14	dB
Input Return Loss	S11	-14	dB
Output Return Loss	S22	-8.6	dB
Output 1 dB Compression Point		24.7	dBm
Output Third-Order Intercept	$\Delta f = 1 \text{ MHz}$. Pout = 5 dBm/tone	41.5	dBm
Noise Figure	,	5.6	dB
AMPLIFIER 2 FREQUENCY = 943 MHz	Using the AMP2IN and AMP2OUT pins		
Gain		16.5	dB
vs. Frequency	±18 MHz	±0.05	dB
vs. Temperature	$-40^{\circ}C \le T_{A} \le +85^{\circ}C$	±0.39	dB
vs. Supply	4.75 V to 5.25 V	±0.10	dB
Input Return Loss	S11	-11.2	dB
Output Return Loss	S22	-8.1	dB
Output 1 dB Compression Point		25.0	dBm
Output Third-Order Intercept	$\Delta f = 1 MHz$, Pout = 5 dBm/tone	43.3	dBm
Noise Figure		5.3	dB
AMPLIFIER 2 FREQUENCY = 1960 MHz	Using the AMP2IN and AMP2OUT pins	5.5	
Gain		14.9	dB
vs. Frequency	±30 MHz	±0.15	dB
Input Return Loss	S11	-14	dB
Output Return Loss	S22	-7.0	dB
Output 1 dB Compression Point		26.0	dBm
Output Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 5 \text{ dBm/tone}$	39.9	dBm
Noise Figure		3.73	dB
AMPLIFIER 2 FREQUENCY = 2140 MHz	Using the AMP2IN and AMP2OUT pins	55	40
Gain		13.0 14.2 15.5	dB
vs. Frequency	±30 MHz	±0.03	dB
vs. Temperature	$-40^{\circ}C \le T_{A} \le +85^{\circ}C$	±0.50	dB
vs. Supply	4.75 V to 5.25 V	±0.09	dB
Input Return Loss	S11	-10.7	dB
Output Return Loss	S22	-10.7	dB
Output 1 dB Compression Point		26.0	dBm
Output Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 5 \text{ dBm/tone}$	41.1	dBm
output milu-order intercept	$\Delta I = I WIIZ, F UUI = J UDIII/UUIR$	41.1	dB

Parameter	Conditions	Min Typ	Max	Unit
AMPLIFIER 2 FREQUENCY = 2630 MHz	Using the AMP2IN and AMP2OUT pins			
Gain		13.0		dB
vs. Frequency	±60 MHz	±0.13		dB
vs. Temperature	$-40^{\circ}C \le T_{A} \le +85^{\circ}C$	±0.56		dB
vs. Supply	4.75 V to 5.25 V	±0.09		dB
Input Return Loss	S11	-9.4		dB
Output Return Loss	S22	-8.3		dB
Output 1 dB Compression Point		24.5		dBm
Output Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 5 \text{ dBm/tone}$	40.4		dBm
Noise Figure		4.1		dB
AMPLIFIER 2 FREQUENCY = 3600 MHz	Using the AMP2IN and AMP2OUT pins			ab
Gain		12.3		dB
vs. Frequency	±200 MHz	±1.23		dB
vs. Temperature	$-40^{\circ}C \le T_{A} \le +85^{\circ}C$	±1.05		dB
vs. Supply	4.75 V to 5.25 V	±0.07		dB
Input Return Loss	S11	-15.0		dB
Output Return Loss	S22	-11.0		dB
•	322	26.2		dBm
Output 1 dB Compression Point				dBm
Output Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 5 \text{ dBm/tone}$	36.2 5.5		dB
Noise Figure		5.5		ав
DSA FREQUENCY = 150 MHz	Using the DSAIN and DSAOUT pins, minimum attenuation			10
Insertion Loss		-1.5		dB
vs. Frequency	±50 MHz	±0.12		dB
vs. Temperature	$-40^{\circ}C \le T_{A} \le +85^{\circ}C$	±0.10		dB
Attenuation Range	Between maximum and minimum attenuation states	28.8		dB
Attenuation Step Error	All attenuation states	±0.18		dB
Attenuation Absolute Error	All attenuation states	±1.35		dB
Input Return Loss		-13.5		dB
Output Return Loss		-13.3		dB
Input Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 5 \text{ dBm/tone}$	48.2		dBm
DSA FREQUENCY = 450 MHz	Using the DSAIN and DSAOUT pins, minimum attenuation			
Insertion Loss		-1.4		dB
vs. Frequency	±50 MHz	±0.02		dB
vs. Temperature	$-40^{\circ}C \le T_A \le +85^{\circ}C$	±0.12		dB
Attenuation Range	Between maximum and minimum attenuation states	30.7		dB
Attenuation Step Error	All attenuation states	±0.14		dB
Attenuation Absolute Error	All attenuation states	±0.39		dB
Input Return Loss		-17.7		dB
Output Return Loss		-17.4		dB
Input Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 5 \text{ dBm/tone}$	44.0		dBm
DSA FREQUENCY = 748 MHz	Using the DSAIN and DSAOUT pins, minimum attenuation			
Insertion Loss		-1.5		dB
vs. Frequency	±50 MHz	±0.02		dB
vs. Temperature	$-40^{\circ}C \le T_A \le +85^{\circ}C$	±0.12		dB
Attenuation Range	Between maximum and minimum attenuation states	30.9		dB
Attenuation Step Error	All attenuation states	±0.15		dB
Attenuation Absolute Error	All attenuation states	±0.30		dB
Input Return Loss		-17.1		dB
Output Return Loss		-17.1		dB
Input Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 5 \text{ dBm/tone}$	44.0		dBm

Parameter	Conditions	Min Typ Ma	x Unit
DSA FREQUENCY = 943 MHz	Using the DSAIN and DSAOUT pins, minimum attenuation		
Insertion Loss		-1.6	dB
vs. Frequency	±18 MHz	±0.01	dB
vs. Temperature	$-40^{\circ}C \leq T_{A} \leq +85^{\circ}C$	±0.13	dB
Attenuation Range	Between maximum and minimum attenuation states	30.9	dB
Attenuation Step Error	All attenuation states	±0.15	dB
Attenuation Absolute Error	All attenuation states	±0.28	dB
Input Return Loss		-16.0	dB
Output Return Loss		-15.9	dB
Input 1 dB Compression Point		30.5	dBm
Input Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 5 \text{ dBm/tone}$	50.7	dBm
DSA FREQUENCY = 1960 MHz	Using the DSAIN and DSAOUT pins, minimum attenuation		
Insertion Loss		-2.5	dB
vs. Frequency	±30 MHz	±0.04	dB
vs. Temperature	$-40^{\circ}C \le T_{A} \le +85^{\circ}C$	±0.18	dB
Attenuation Range	Between maximum and minimum attenuation states	30.8	dB
Attenuation Step Error	All attenuation states	±0.15	dB
Attenuation Absolute Error	All attenuation states	±0.35	dB
Input Return Loss		-10.3	dB
Output Return Loss		-9.6	dB
Input 1 dB Compression Point		31.5	dBm
Input Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 5 \text{ dBm/tone}$	49.6	dBm
DSA FREQUENCY = 2140 MHz	Using the DSAIN and DSAOUT pins, minimum attenuation		
Insertion Loss		-2.6	dB
vs. Frequency	±30 MHz	±0.02	dB
vs. Temperature	$-40^{\circ}C \le T_A \le +85^{\circ}C$	±0.19	dB
Attenuation Range	Between maximum and minimum attenuation states	30.9	dB
Attenuation Step Error	All attenuation states	±0.13	dB
Attenuation Absolute Error	All attenuation states	±0.32	dB
Input Return Loss		-9.8	dB
Output Return Loss		-9.3	dB
Input 1 dB Compression Point		31.5	dBm
Input Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 5 \text{ dBm/tone}$	49.6	dBm
DSA FREQUENCY = 2630 MHz	Using the DSAIN and DSAOUT pins, minimum attenuation		
Insertion Loss		-2.8	dB
vs. Frequency	±60 MHz	±0.02	dB
vs. Temperature	$-40^{\circ}C \le T_{A} \le +85^{\circ}C$	±0.21	dB
Attenuation Range	Between maximum and minimum attenuation states	31.2	dB
Attenuation Step Error	All attenuation states	±0.18	dB
Attenuation Absolute Error	All attenuation states	±0.24	dB
Input Return Loss		-10.0	dB
Output Return Loss		-9.6	dB
Input 1 dB Compression Point		31.5	dBm
Input Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 5 \text{ dBm/tone}$	48.3	dBm

Parameter	Conditions	Min	Тур	Max	Unit
DSA FREQUENCY = 3600 MHz	Using the DSAIN and DSAOUT pins, minimum attenuation				
Insertion Loss			-3.0		dB
vs. Frequency	±100 MHz		±0.02		dB
vs. Temperature	$-40^{\circ}C \le T_{A} \le +85^{\circ}C$		±0.23		dB
Attenuation Range	Between maximum and minimum attenuation states		31.7		dB
Attenuation Step Error	All attenuation states		±0.38		dB
Attenuation Absolute Error	All attenuation states		±0.35		dB
Input Return Loss			-12.3		dB
Output Return Loss			-11.7		dB
Input 1 dB Compression Point			31.0		dBn
Input Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 5 \text{ dBm/tone}$		46.2		dBn
DSA Gain Settling	Using the DSAIN and DSAOUT pins				
Minimum Attenuation to Maximum Attenuation			36		ns
Maximum Attenuation to Minimum Attenuation			36		ns
LOOP FREQUENCY = 150 MHz	AMP1 – DSA – AMP2, DSA at minimum attenuation				
Gain			37.4		dB
vs. Frequency	±50 MHz		±0.1		dB
Gain Range	Between maximum and minimum attenuation states		28.0		dB
Input Return Loss	S11		-10.0		dB
Output Return Loss	S22		-7.0		dB
Output 1 dB Compression Point			22.5		dBr
Output Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 5 \text{ dBm/tone}$		38.5		dBr
Noise Figure			3.0		dB
LOOP FREQUENCY = 450 MHz	AMP1 – DSA – AMP2, DSA at minimum attenuation		5.0		ub
Gain	AWIFT - DSA - AWIFZ, DSA at Minimum attendation		35.8		dB
	±50 MHz		±0.43		dB
vs. Frequency Gain Range	Between maximum and minimum attenuation states		10.45 31.0		dB
-	S11		-12.5		dB
Input Return Loss	S11 S22		-12.5 -6.4		dВ
Output Return Loss	522				ав dBr
Output 1 dB Compression Point			23.1		
Output Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 5 \text{ dBm/tone}$		37.6		dBn
Noise Figure			3.1		dB
LOOP FREQUENCY = 943 MHz	AMP1–DSA–AMP2, DSA at minimum attenuation				10
Gain			34.0		dB
vs. Frequency	±18 MHz		±0.10		dB
Gain Range	Between maximum and minimum attenuation states		29.3		dB
Input Return Loss	S11		-14.2		dB
Output Return Loss	S22		-10.1		dB
Output 1 dB Compression Point			25.1		dBn
Output Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 5 \text{ dBm/tone}$		42.8		dBr
Noise Figure			2.9		dB
LOOP FREQUENCY = 2140 MHz	AMP1 – DSA – AMP2, DSA at minimum attenuation				
Gain			31.3		dB
vs. Frequency	±30 MHz		±0.03		dB
Gain Range	Between maximum and minimum attenuation states		32.5		dB
Input Return Loss	S11		-9.3		dB
Output Return Loss	S22		-5.4		dB
Output 1 dB Compression Point			25.3		dBr
Output Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 5 \text{ dBm/tone}$		40.0		dBr
Noise Figure			3.1		dB

Parameter	Conditions	Min	Тур	Max	Unit
LOOP FREQUENCY = 2630 MHz	AMP1 – DSA – AMP2, DSA at minimum attenuation				
Gain			29.5		dB
vs. Frequency	±60 MHz		±0.56		dB
Gain Range	Between maximum and minimum attenuation states		30.0		dB
Input Return Loss	S11		-12.6		dB
Output Return Loss	S22		-5.8		dB
Output 1 dB Compression Point			24.6		dBm
Output Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 5 \text{ dBm/tone}$		39.3		dBm
Noise Figure			3.1		dB
LOOP FREQUENCY = 3600 MHz	AMP1 – DSA – AMP2, DSA at minimum attenuation				
Gain			26.5		dB
vs. Frequency	±200 MHz		±1.3		dB
Gain Range	Between maximum and minimum attenuation states		33.0		dB
Input Return Loss	S11		-8.0		dB
Output Return Loss	S22		-8.0		dB
Output 1 dB Compression Point			24.7		dBm
Output Third-Order Intercept	$\Delta f = 1 \text{ MHz}, P_{OUT} = 5 \text{ dBm/tone}$		36.0		dBm
Noise Figure			3.7		dB
LOGIC INPUTS	CLK, DATA, LE, SEL, D0~D6				
Input High Voltage, V _{INH}		2.5			V
Input Low Voltage, VINL				0.8	V
Input Current, I _{INH} /I _{INL}			0.1		μA
Input Capacitance, C _{IN}			1.5		рF
POWER SUPPLIES					
Voltage		4.75	5.0	5.25	V
Supply Current	AMP1		89	120	mA
	AMP2		86	120	mA
	DSA		0.5		mA

ABSOLUTE MAXIMUM RATINGS

Table 2.

Parameter	Rating
Supply Voltage (VDD, VCC, VCC2)	6.5 V
Input Power	
AMP1IN	16 dBm
AMP2IN (50 Ω Impedance)	20 dBm
DSAIN	30 dBm
Internal Power Dissipation	1.0 W
θ_{JA} (Exposed Paddle Soldered Down)	34.8°C/W
θ _{JC} (Exposed Paddle)	6.2°C/W
Maximum Junction Temperature	150°C
Lead Temperature (Soldering, 60 sec)	240°C
Operating Temperature Range	-40°C to +85°C
Storage Temperature Range	–65°C to +150°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



NOTES 1. NC = NO CONNECT. DO NOT CONNECT TO THIS PIN. 2. THE EXPOSED PAD MUST BE CONNECTED TO GROUND.

Figure 2. Pin Configuration

Pin No.	Mnemonic	Description
1, 24	VDD	Supply Voltage for DSA. Connect this pin to a 5 V supply.
2, 3, 5, 7, 8, 9, 11, 12, 13, 14, 17, 18, 20, 22, 23	NC	No Connect. Do not connect to this pin.
4	DSAIN	RF Input to DSA.
6	AMP1OUT/VCC	RF Output from Amplifier 1/Supply Voltage for Amplifier 1. Bias to Gain Block Amplifier 1 is provided through a choke to this pin when connected to VCC.
10	AMP1IN	RF Input to Gain Block Amplifier 1.
15	AMP2OUT/VCC2	RF Output from Amplifier 2/Supply Voltage for Amplifier 2. Bias to Driver Amplifier 2 is provided through a choke to this pin when connected to VCC2.
16	VBIAS	Bias for Driver Amplifier 2.
19	AMP2IN	RF Input to Amplifier 2.
21	DSAOUT	RF Output from DSA.
25	D6	Data Bit in Parallel Mode (LSB). Connect to supply in serial mode.
26	D5	Data Bit in Parallel Mode. Connect to ground in serial mode.
27	D4	Data Bit in Parallel Mode. Connect to ground in serial mode.
28	D3	Data Bit in Parallel Mode. Connect to ground in serial mode.
29	D2/LE	Data Bit in Parallel Mode/Latch Enable in Serial Mode.
30	D1/DATA	Data Bit in Parallel Mode (MSB)/Data in Serial Mode.
31	D0/CLK	Connect this pin to ground in parallel mode. This pin functions as a clock in serial mode.
32	SEL	Select Pin. For parallel mode operation , connect this pin to the supply. For serial mode operation, connect this pin to ground.
	EPAD	Exposed Paddle. The exposed paddle must be connected to ground.

TYPICAL PERFORMANCE CHARACTERISTICS



Figure 3. AMP1: Gain, P1dB, OIP3 at P_{OUT} = 3 dBm/Tone and Noise Figure vs. Frequency



Figure 4. AMP1: Gain vs. Frequency and Temperature



Figure 5. AMP1: Input Return Loss (S11), Output Return Loss (S22), and Reverse Isolation (S12) vs. Frequency



Figure 6. AMP1: OIP3 at $P_{OUT} = 3 dBm/Tone$ and P1dB vs. Frequency and Temperature



Figure 8. AMP1: Noise Figure vs. Frequency and Temperature

50 0IP3 45 0IP3 60 0IP3 90 35 20 0IP3 21 0IP3 22 0IP3 20 0IP3

Figure 9. AMP2–943 MHz: Gain, P1dB, OIP3 at $P_{OUT} = 5$ dBm/Tone and Noise Figure vs. Frequency



Figure 10. AMP2-943 MHz: Gain vs. Frequency and Temperature



Figure 11. AMP2–943 MHz: Input Return Loss (S11), Output Return Loss (S22), and Reverse Isolation (S12) vs. Frequency



Figure 12. AMP2–943 MHz: OIP3 at $P_{OUT} = 5 \text{ dBm/Tone}$ and P1dB vs. Frequency and Temperature









Figure 15. AMP2–2140 MHz: Gain, P1dB, OIP3 at P_{OUT} = 5 dBm/Tone and Noise Figure vs. Frequency



Figure 16. AMP2–2140 MHz: Gain vs. Frequency and Temperature



Figure 17. AMP2–2140 MHz: Input Return Loss (S11), Output Return Loss (S22), and Reverse Isolation (S12) vs. Frequency



Figure 18. AMP2–2140 MHz: OIP3 at $P_{OUT} = 5 \text{ dBm/Tone}$ and P1dB vs. Frequency and Temperature





Figure 20. AMP2–2140 MHz: Noise Figure vs. Frequency and Temperature

45 dBm) OIP3 40 P1dB, OIP3 (dB, 35 30 P1dB 25 NOISE FIGURE, GAIN, 20 15 GAIN 10 NF 5 0 09431-021 2.57 2.59 2.61 2.63 2.65 2.67 2.69 FREQUENCY (GHz)

Figure 21. AMP2–2630 MHz: Gain, P1dB, OIP3 at P_{out} = 5 dBm/Tone and Noise Figure vs. Frequency



Figure 22. AMP2–2630 MHz: Gain vs. Frequency and Temperature







Figure 24. AMP2–2630 MHz: OIP3 at $P_{OUT} = 5 dBm/Tone$ and P1dB vs. Frequency and Temperature





Figure 26. AMP2–2630 MHz: Noise Figure vs. Frequency and Temperature



Figure 32. DSA: Output Return Loss vs. Frequency, All States



Figure 33. DSA: Input P1dB and Input IP3 vs. Frequency, Minimum Attenuation State



Figure 34. DSA: Gain Settling Time, 0 dB to 31.5 dB



Figure 35. DSA: Gain Settling Time, 31.5 dB to 0 dB





Figure 37. Loop–943 MHz: Gain, P1dB, OIP3 at Pout = 5 dBm/Tone and Noise Figure vs. Frequency, Minimum Attenuation State







Figure 39. Loop–943 MHz: OIP3 vs. P_{OUT} and Frequency, Minimum Attenuation State



Figure 40. Loop–2140 MHz: Gain, P1dB, OIP3 at P_{OUT} = 5 dBm/Tone and Noise Figure vs. Frequency, Minimum Attenuation State



Figure 41. Loop–2140 MHz: Input Return Loss (S11), Output Return Loss (S22), and Reverse Isolation (S12) vs. Frequency, Minimum Attenuation State



Figure 42. Loop–2140 MHz: OIP3 vs. P_{OUT} and Frequency, Minimum Attenuation State



Figure 43. Loop–2630 MHz: Gain, P1dB, OIP3 at P_{OUT} = 5 dBm/Tone and Noise Figure vs. Frequency, Minimum Attenuation State



Figure 44. Loop–2630 MHz: Input Return Loss (S11), Output Return Loss (S22), and Reverse Isolation (S12) vs. Frequency, Minimum Attenuation State



Figure 45. Loop–2630 MHz: OIP3 vs. Pour and Frequency, Minimum Attenuation State



Figure 46. AMP1: Supply Current vs. Voltage and Temperature



Figure 47. AMP1: Supply Current vs. Pout and Temperature



Figure 48. AMP2: Supply Current vs. Voltage and Temperature



Figure 49. AMP2: Supply Current vs. POUT and Temperature









APPLICATIONS INFORMATION

BASIC LAYOUT CONNECTIONS

The basic connections for operating the ADL5243 are shown in Figure 58. The schematic of AMP2 is configured for 2140 MHz operation.



Amplifier 1 Power Supply

AMP1 in the ADL5243 is a broadband gain block. The dc bias is supplied through Inductor L1 and is connected to the AMP1OUT pin. Three decoupling capacitors (C13, C14, and C25) are used to prevent RF signals from propagating on the dc lines. The dc supply ranges from 4.75 V to 5.25 V and should be connected to the VCC test pin.

Amplifier 1 RF Input Interface

Pin 10 is the RF input for AMP1 of the ADL5243. The amplifier is internally matched to 50 Ω at the input; therefore, no external components are required. Only a dc blocking capacitor (C21) is required.

Amplifier 1 RF Output Interface

Pin 6 is the RF output for AMP1 of the ADL5243. The amplifier is internally matched to 50 Ω at the output as well; therefore, no external components are required. Only a dc blocking capacitor (C4) is required. The bias is provided through this pin via a choke inductor, L1.

Amplifier 2 Power Supply

The collector bias for AMP2 is supplied through Inductor L2 and is connected to the AMP2OUT pin, whereas the base bias is provided through Pin 16. The base bias is connected to the same supply pin as the collector bias. Three decoupling capacitors (C3, C20, and C25) are used to prevent RF signals from propagating on the dc lines. The dc supply ranges from 4.75 V to 5.25 V and should be connected to the VCC2 test pin.

Amplifier 2 RF Input Interface

Pin 19 is the RF input for AMP2 of the ADL5243. The input of the amplifier is easily matched to 50 Ω with a combination of series and shunt capacitors and a microstrip line serving as an inductor. Figure 58 shows the input matching components and is configured for 2140 MHz.

Amplifier 2 RF Output Interface

Pin 15 is the RF input for AMP2 of the ADL5243. The output of the amplifier is easily matched to 50 Ω with a combination of series and shunt capacitors and a microstrip line serving as an inductor.

Additionally, bias is provided through this pin. Figure 58 shows the output matching components and is configured for 2140 MHz.

DSA RF Input Interface

Pin 4 is the RF input for the DSA of the ADL5243. The input impedance of the DSA is close to 50 Ω over the entire frequency range; therefore, no external components are required. Only a dc blocking capacitor (C1) is required.

DSA RF Output Interface

Pin 21 is the RF output for the DSA of the ADL5243. The output impedance of the DSA is close to 50 Ω over the entire frequency range; therefore, no external components are required. Only a dc blocking capacitor (C5) is required.

DSA SPI Interface

The DSA of the ADL5243 can operate in either serial or parallel mode. Pin 32 (SEL) controls the mode of operation. For serial mode operation, connect SEL to ground, and for parallel mode operation, connect SEL to VDD. In parallel mode, Pin 25 to Pin 30 (D6 to D1) are the data bits, with D6 being the LSB. Connect Pin 31 (D0) to ground during parallel mode of operation. In serial mode, Pin 29 is the latch enable (LE), Pin 30 is the data (DATA), and Pin 31 is the clock (CLK). Pin 26, Pin 27, and Pin 28 are not used in the serial mode and should be connected to ground. Pin 25 (D6) should be connected to VDD during the serial mode of operation. To prevent noise from coupling onto the digital signals, an RC filter can be used on each data line.

SPI TIMING

SPI Timing Sequence

Figure 60 shows the timing sequence for the SPI function using a 6-bit operation. The clock can be as fast as 20 MHz. In serial mode operation, Register B5 (MSB) is first, and Register B0 (LSB) is last.

Table 4. Mode Selection Table

Pin 32 (SEL)	Functionality
Connect to Ground	Serial mode
Connect to Supply	Parallel mode

Parameter	Limit	Unit	Test Conditions/Comments	
F _{CLK}	10	MHz	Data clock frequency	
t1	30	ns min	Clock high time	
t ₂	30	ns min	Clock low time	
t ₃	10	ns min	Data to clock setup time	
t ₄	10	ns min	Clock to data hold time	
ts	10	ns min	Clock low to LE setup time	
t ₆	30	ns min	LE pulse width	



Table 6. DSA Attenuation Truth Table—Serial Mode

Attenuation State	B5 (MSB)	B4	B3	B2	B1	B0 (LSB)
0 dB (Reference)	1	1	1	1	1	1
0.5 dB	1	1	1	1	1	0
1.0 dB	1	1	1	1	0	1
2.0 dB	1	1	1	0	1	1
4.0 dB	1	1	0	1	1	1
8.0 dB	1	0	1	1	1	1
16.0 dB	0	1	1	1	1	1
31.5 dB	0	0	0	0	0	0

Table 7. DSA Attenuation Truth Table—Parallel Mode

Attenuation State	D1 (MSB)	D2	D3	D4	D5	D6 (LSB)
0 dB (Reference)	1	1	1	1	1	1
0.5 dB	1	1	1	1	1	0
1.0 dB	1	1	1	1	0	1
2.0 dB	1	1	1	0	1	1
4.0 dB	1	1	0	1	1	1
8.0 dB	1	0	1	1	1	1
16.0 dB	0	1	1	1	1	1
31.5 dB	0	0	0	0	0	0

ADL5243 AMPLIFIER 2 MATCHING

The AMP2 input and output of the ADL5243 can be matched to 50 Ω with two or three external components and the microstrip line used as an inductor. Table 8 lists the required matching components values. All capacitors are Murata GRM155 series (0402 size), and Inductor L2 is a Coilcraft^{*} 0603CS series (0603 size). For all frequency bands, the placement of Capacitors C22, C26, and C28 is critical.

Table 9 lists the recommended component spacing of C22, C26, and C28 for the various frequencies. The placement of R12 and C27 is fixed for the matching network on evaluation board and

the spacing is 153 mils and 25 mils respectively. The component spacing is referenced from the center of the component to the edge of the package. Figure 61 to Figure 69 show the graphical representation of the matching network. It is recommended to configure a RC feedback network and bias the AMP2 input through external R for optimal performance at-frequency bands less than 500 MHz as shown at Figure 61 and Figure 62. In this case, VBIAS pin must be left open.

Frequency	C27	C26	C28	C8	C22	C23	L2	R10	R20 ¹	R12	R16	R15	C10	R31	R30
150 MHz	2.7n H	1.5 pF	N/A	1500 pF	0.5 pF	4700 pF	390 nH	21 Ω	N/A	22 nH	3.16 kΩ	750 Ω	1 nF	0Ω	N/A
450 MHz	0Ω	N/A	5.1pF	1000 pF	0.5 pF	1000 pF	110 nH	21 Ω	5.6 Ω	3.9 nH	3.16 kΩ	750 Ω	1 nF	0Ω	N/A
748 MHz	0Ω	N/A	5.1 pF	12 pF	1.3 pF	18 pF	56 nH	18 Ω	5.6 Ω	3.9 nH	N/A	N/A	N/A	N/A	0Ω
943 MHz	0Ω	3.9 pF	N/A	6 pF	1.3 pF	100 pF	56 nH	18 Ω	N/A	3.3 nH	N/A	N/A	N/A	N/A	0Ω
1960 MHz	2.7 pF	N/A	1.0 pF	10 pF	1.0 pF	20 pF	9.5 nH	0Ω	N/A	0Ω	N/A	N/A	N/A	N/A	0Ω
2140 MHz	2.2 pF	N/A	1.8 pF	10 pF	1.0 pF	10 pF	9.5 nH	0Ω	N/A	0Ω	N/A	N/A	N/A	N/A	0Ω
2350 MHz	3.3 pF	1.6 pF	1.5 KΩ	10 pF	1.0 pF	20 pF	9.5 nH	0Ω	N/A	0Ω	N/A	N/A	N/A	N/A	0Ω
2630 MHz	2.7 pF	1.1 pF	1.5 KΩ	10 pF	1.3 pF	20 pF	9.5 nH	0Ω	N/A	0Ω	N/A	N/A	N/A	N/A	0Ω
3600 MHz	1.0 pF	1.5 KΩ	1.2 pF	10 pF	1.2 pF	20 pF	9.5 nH	0Ω	N/A	1.0 nH	N/A	N/A	N/A	N/A	0Ω

 Table 8. Component Values on Evaluation Board

¹ R20 is not reserved on the evaluation board.

Table 9. Component Spacing on Evaluation Board

Frequency	C26 : λ1(mils)	C28 : λ2(mils)	C22 : λ3(mils)
150 MHz	213	N/A	408
450 MHz	N/A	230	485
748 MHz	N/A	315	201
943 MHz	236	N/A	394
1960 MHz	N/A	366	244
2140 MHz	N/A	366	244
2350 MHz	153	195	244
2630 MHz	126	161	240
3600 MHz	342	366	106



Figure 61. AMP2: Matching Circuit at 150 MHz



Figure 62. AMP2: Matching Circuit at 450 MHz



Figure 64. AMP2: Matching Circuit at 943 MHz



Figure 65. AMP2: Matching Circuit at 1960 MHz





09431-064







Figure 68. AMP2: Matching Circuit at 2630 MHz

09431-065





ADL5243 LOOP PERFORMANCE

The typical configuration of the ADL5243 is to connect in AMP1-DSA-AMP2 mode, as shown in Figure 70. Because AMP1 and DSA are broadband in nature and internally matched, only an ac coupling capacitor is required between them. The AMP2 is externally matched for each frequency band of operation, and these matching elements should be placed between the DSA and AMP2 and at the output of AMP2. Matching circuits for AMP2 are shown in Figure 61 through Figure 69. This works well in a loop in each case but matching circuits between the DSA and AMP2 requires slight retuning, such as adding a shunt capacitor at the DSA output or changing the location of a shunt capacitor for optimum performance in a loop at certain frequency bands. Figure 71 and Figure 72 show the retuned matching circuits from Figure 66 and Figure 69 at 2140 MHz and 3600 MHz, respectively. Figure 37 to Figure 45 show the performance of the ADL5243 when connected in a loop for the three primary frequency bands of operation, namely 943 MHz, 2140 MHz, and 2630 MHz.

Frequency	C26: λ1 (mils)	C28: λ2 (mils)	C22: λ3 (mils)	C11: λ4 (mils)
2140 MHz	N/A	366	244	122
3600 MHz	126	342	106	N/A



Figure 70. ADL5243 Loop Block Diagram





Figure 72. ADL5243 Matching Circuit at 3600 MHz in a Loop

PROPER DRIVING LEVEL FOR THE OPTIMUM ACLR

It is usually required to drive the amplifier as high as possible in order to maximize output power. However, properly driving AMP1 and AMP2 at the ADL5243 is required to achieve optimum ACLR performance. Once output power approaches P1dB and OIP3, there is ACLR degradation. The driving level of amplifier with a modulated signal should be backed off properly from P1dB by at least the amount of a signal crest factor for optimum ACLR. So assuming a gain and P1dB of AMP1 at 2140 MHz are 19 dB and 19 dBm respectively, the output power, which is backed off by 11 dB crest factor at the modulated signal case, is 8 dBm. Therefore, the proper input driving level should be under –11 dBm.



Figure 73. Single Carrier WCDMA Adjacent Chanel Power Ratio vs. Input Power at AMP1 and AMP2, 2140 MHz

THERMAL CONSIDERATIONS

The ADL5243 is packaged in a thermally efficient, 5 mm × 5 mm, 32-lead LFCSP. The thermal resistance from junction to air (θ_{JA}) is 34.8°C/W. The thermal resistance for the product was extracted assuming a standard 4-layer JEDEC board with 25 copper platter thermal vias. The thermal vias are filled with conductive copper paste, AE3030, with a thermal conductivity of 7.8 W/mk and thermal expansion as follows: $\alpha 1$ of 4×10^{-5} /°C and $\alpha 2$ of 8.6×10^{-5} /°C. The thermal resistance from junction to case (θ_{JC}) is 6.2°C/W, where case is the exposed pad of the lead frame package.

For the best thermal performance, it is recommended to add as many thermal vias as possible under the exposed pad of the LFCSP. The above thermal resistance numbers assume a minimum of 25 thermal vias arranged in a 5×5 array with a via diameter of 13 mils, via pad of 25 mils, and pitch of 25 mils. The vias are plated with copper, and the drill hole is filled with a conductive copper paste. For optimal performance, it is recommended to fill the thermal vias with a conductive paste of equivalent thermal conductivity, as mentioned above, or use an external heat sink to dissipate the heat quickly without affecting the die junction temperature. It is also recommended to extend the ground pattern as shown in Figure 74 to improve thermal efficiency.

SOLDERING INFORMATION AND RECOMMENDED PCB LAND PATTERN

Figure 74 shows the recommended land pattern for the ADL5243. To minimize thermal impedance, the exposed paddle on the 5 mm \times 5 mm LFCSP package is soldered down to a ground plane. To improve thermal dissipation, 25 thermal vias are arranged in a 5 \times 5 array under the exposed paddle. If multiple ground layers exist, they should be tied together using vias. For more information on land pattern design and layout, see the AN-772 Application Note, *A Design and Manufacturing Guide for the Lead Frame Chip Scale Package (LFCSP)*.



Figure 74. Recommended Land Pattern

EVALUATION BOARD

The schematic of the ADL5243 evaluation board is shown in Figure 75. All RF traces on the evaluation board have a characteristic impedance of 50 Ω and are fabricated from Rogers3003 material. The traces are CPWG with a width of 25 mils, spacing of 20 mils, and dielectric thickness of 10 mils. The input and output to the DSA and amplifier should be ac-coupled with capacitors of an appropriate value to ensure broadband performance. The bias to AMP1 is provided through a choke connected to the AMP1OUT pin and, similarly, bias to AMP2 is provided through a choke connected to the AMP2OUT pin. Bypassing capacitors are recommended on all supply lines to minimize RF coupling. The DSA and the amplifiers can be individually biased or connected to the VDD plane through Resistors R1, R2, and R11. The schematic of AMP2 on evaluation board is configured for 2140 MHz operation.

When configuring the ADL5243 evaluation board in the AMP1-DSA-AMP2 loop, remove Capacitors C1, C4, C5, and C8 and remove Resistor R10. Place 10 pF in place of C24 and C6, and 0 Ω in place of R32 and R33. If needed, placing a shunt capacitor (1.3 pF) at the output of the DSA improves the output return loss of this loop as described at the ADL5243 Loop Performance section.

Table 11. Evaluation Board Configurations Options

On the digital signal traces, provisions for an RC filter are made to clean any potential coupled noise. In normal operation, series resistors are 0 Ω and shunt resistors and capacitors are open.

The evaluation board is designed to control DSA in either parallel or serial mode by connecting the SEL pin to the supply or ground by a switch.

For adjusting attenuation at DSA, the ADL5243 can be programmed in two ways: through the on-board USB interface from a PC USB port, or through an SDP board, which will become the Analog Devices common control board in the future. The on-board USB interface circuitry of the evaluation board is powered directly by the PC. USB based programming software is available to download from the ADL5243 product page at *www.analog.com*. Figure 71 shows the window of the programming software where the user selects serial or parallel mode for the attenuation adjustment at DSA. The selection of the mode in the window should match the mode of the evaluation board switch.

It is highly recommended to refer the evaluation board layout for the optimal and stable performance of each block as well as for the improvement of thermal efficiency.

Component	Function	Default Value
C1, C5	AC coupling caps for DSA.	C1, C5 = 10 pF
C4, C21	AC coupling capacitors for AMP1.	C4, C21 = 10 pF
C13, C14, C15	Power supply bypassing capacitors for AMP1. Capacitor C15 should be closest to the device.	C13 = 10 μF C14 = 10 nF C15 = 10 pF
L1	The bias for AMP1 comes through L1 when connected to a 5 V supply. L1 should be high impedance for the frequency of operation, while providing low resistance for the dc current.	L1 = 33 nH
C8	AMP2 input ac coupling capacitor.	C8 = 10 pF
C23	AMP2 output ac coupling capacitor.	C23 = 10 pF
C22	AMP2 shunt output tuning capacitor.	C22 = 1.0 pF at 244 mils from edge of package
C26	ANP2 shunt input tuning capacitor.	DNP
C27	AMP2 series input tuning capacitor.	C27 = 2.2 pF
C28	AMP2 shunt input tuning capacitor.	C28 = 1.8 pF at 366 mils from edge of package
C3, C25, C20	Power supply bypassing capacitors for AMP2. Capacitor C3 should be closest to the device.	C3 = 10 pF C25 = 10 nF C20 = 10 µF
L2	The bias for AMP2 comes through L2 when connected to a 5 V supply. L2 should be high impedance for the frequency of operation, while providing low resistance for the dc current.	L2 = 9.5 nH
C17	Power supply bypassing capacitor for DSA.	C17 = 0.1 μF
R10, R12	Placeholder for the series component for the other frequency band.	R10, R12 = 0 Ω
C6, C24, R32, R33	Replace with capacitors and resistors to connect the device in a loop.	C6 , C24, R32, R33 = open
R1, R2, R11	Resistors to connect the supply for the amplifier and the DSA to the same VDD plane.	R1, R2 = open
S1	Switch to change between serial and parallel mode operation; connect to a supply for parallel mode and to ground for serial mode operation.	3-pin rocker

Data Sheet



ADL5243



Figure 76. USB/SDP Interface Circuitry on the Customer Evaluation Board Rev. B | Page 35 of 40

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Figure 78. Evaluation Board Layout—Bottom

<u>^</u>	 Serial Mode Parallel Mod 		-
Preset Attend	uation Value 1	0	set
Preset Attenu	lation Value 2	0.5	set
Preset Attenu	uation Value 3	1.0	set
Preset Attenu	uation Value 4	2.0	set
Preset Attend	uation Value 5	4.0	set
Preset Attenu	uation Value 6	8.0	set
Preset Attenu	uation Value 7	16.0	set
Preset Attenu	uation Value 8	31.5	set
- Attenuation			

Figure 79. Evaluation Board Control Software

OUTLINE DIMENSIONS



(CP-32-3)

Dimensions shown in millimeters

ORDERING GUIDE

Model ¹	Temperature Range	Package Description	Package Option
ADL5243ACPZ-R7	-40°C to +85°C	32-Lead Lead Frame Chip Scale Package LFCSP_VQ	CP-32-3
ADL5243-EVALZ		Evaluation Board	

 1 Z = RoHS Compliant Part.

NOTES

NOTES



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